

# Hyper 5 mm (T1 ¾) LED, Diffused Hyper-Bright LED

LY 5456



## Vorläufige Daten / Preliminary Data

### Besondere Merkmale

- **Gehäusetyp:** nicht eingefärbtes, diffuses 5 mm (T1 ¾) Gehäuse
- **Besonderheit des Bauteils:** Lötspieße ohne Aufsetzebene
- **Wellenlänge:** 589 nm
- **Abstrahlwinkel:** 50°
- **Technologie:** InGaAlP
- **optischer Wirkungsgrad:** 11 lm/W
- **Gruppierungsparameter:** Lichtstärke
- **Lötmethode:** Wellenlöten (TTW)
- **Verpackung:** Schüttgut, gegurtet lieferbar

### Anwendungen

- optischer Indikator
- Hinterleuchtung (Schalter, Tasten, Displays, Werbebeleuchtung, Allgemeinbeleuchtung)
- Informationsanzeigen im Innen- und Außenbereich (z.B. im Verkehrsbereich; Laufschriftanzeigen)
- Innenbeleuchtung im Automobilbereich (z.B. Schalterbeleuchtung, u.ä.)
- Markierungsbeleuchtung (z.B. Stufen, Fluchtwege, u.ä.)
- Signal- und Symbolleuchten

### Features

- **package:** colorless, diffused 5 mm (T1 ¾) package
- **feature of the device:** Solder leads without stand-off
- **wavelength:** 589 nm
- **viewing angle:** 50°
- **technology:** InGaAlP
- **optical efficiency:** 11 lm/W
- **grouping parameter:** luminous intensity
- **soldering methods:** TTW soldering
- **packing:** bulk, available taped on reel

### Applications

- optical indicators
- backlighting (switches, keys, displays, illuminated advertising, general lighting)
- indoor and outdoor displays (e.g. displays for traffic; light writing displays)
- interior automotive lighting (e.g. key backlighting, etc.)
- marker lights (e.g. steps, exit ways, etc.)
- signal and symbol luminaire

Typ	Emissions- farbe	Gehäusefarbe	Lichtstärke	Lichtstrom	Bestellnummer
Type	Color of Emission	Color of Package	Luminous Intensity $I_F = 20 \text{ mA}$ $I_V \text{ (mcd)}$	Luminous Flux $I_F = 20 \text{ mA}$ $\Phi_V \text{ (lm)}$	Ordering Code
LY 5456-QS LY 5456-R LY 5456-S LY 5456-ST	yellow	colorless, diffused	71 ... 280 112 ... 180 180 ... 280 180 ... 450	340 (typ.) 270 (typ.) 430 (typ.) 530 (typ.)	on request

Helligkeitswerte werden mit einer Stromeinprägedauer von 25 ms und einer Genauigkeit von  $\pm 11 \%$  ermittelt.  
Luminous intensity is tested at a current pulse duration of 25 ms and an accuracy of  $\pm 11 \%$ .

*Anm.: Die Standardlieferform von Serientypen beinhaltet eine untere bzw. eine obere Familiengruppe oder mindestens zwei Einzelgruppen.*

*In einer Verpackungseinheit / Gurt ist immer nur eine Helligkeitsgruppe enthalten.*

*Die technologiebedingte Helligkeits-Streuung der heutigen LED-Herstellprozesse über einen längeren Fertigungszeitraum (Halbleitermaterial - Chipherstellung - Montageprozess) erlaubt keine Zusage einer einzelnen Helligkeitsgruppe. Daher müssen mindestens zwei Helligkeitsgruppen vorgesehen werden!*

*Note: The standard shipping format for serial types includes a lower or upper family group or at least two individual groups.*

*No packing unit / tape ever contains more than one luminous intensity group.*

*Luminosity variations caused by the technology used in current LED manufacturing processes over a protracted manufacturing period (semiconductor material - chip fabrication - assembly process) mean that it is not possible to assign LEDs to a single luminous intensity group. For this reason at least two luminous intensity groups must be provided!*

**Grenzwerte**  
**Maximum Ratings**

Bezeichnung Parameter	Symbol Symbol	Wert Value	Einheit Unit
Betriebstemperatur Operating temperature range	$T_{op}$	- 55 ... + 100	°C
Lagertemperatur Storage temperature range	$T_{stg}$	- 55 ... + 100	°C
Sperrschichttemperatur Junction temperature	$T_j$	+ 100	°C
Durchlassstrom Forward current	$I_F$	30	mA
Stoßstrom Surge current $t \leq 10 \mu s, D = 0.005$	$I_{FM}$	0.2	A
Sperrspannung Reverse voltage	$V_R$	3	V
Leistungsaufnahme Power consumption $T_A \leq 25 \text{ °C}$	$P_{tot}$	80	mW
Wärmewiderstand Thermal resistance Sperrschicht/Umgebung Junction/ambient	$R_{th JA}$	500	K/W
Sperrschicht/Löt看垫 Junction/solder point Montage auf PC-Board FR 4 (Padgröße $\geq 16 \text{ mm}^2$ ) mounted on PC board FR 4 (pad size $\geq 16 \text{ mm}^2$ ) Minimale Beinchenlänge Minimum lead length	$R_{th JS}$	280	K/W

**Kennwerte** ( $T_A = 25\text{ °C}$ )**Characteristics**

Bezeichnung Parameter	Symbol Symbol	Wert Value	Einheit Unit
Wellenlänge des emittierten Lichtes (typ.) Wavelength at peak emission $I_F = 20\text{ mA}$	$\lambda_{\text{peak}}$	591	nm
Dominantwellenlänge (typ.) Dominant wavelength $I_F = 20\text{ mA}$	$\lambda_{\text{dom}}$	589	nm
Spektrale Bandbreite bei 50 % $I_{\text{rel max}}$ (typ.) Spectral bandwidth at 50 % $I_{\text{rel max}}$ $I_F = 20\text{ mA}$	$\Delta\lambda$	15	nm
Abstrahlwinkel bei 50 % $I_V$ (Vollwinkel) (typ.) Viewing angle at 50 % $I_V$	$2\phi$	50	Grad deg.
Durchlassspannung <sup>1)</sup> (typ.) Forward voltage <sup>1)</sup> (max.) $I_F = 20\text{ mA}$	$V_F$ $V_F$	2.0 2.4	V V
Sperrstrom (typ.) Reverse current (max.) $V_R = 5\text{ V}$	$I_R$ $I_R$	0.01 10	$\mu\text{A}$ $\mu\text{A}$
Temperaturkoeffizient von $\lambda_{\text{peak}}$ (typ.) Temperature coefficient of $\lambda_{\text{peak}}$ $I_F = 20\text{ mA}; -10\text{ °C} \leq T \leq 100\text{ °C}$	$TC_{\lambda_{\text{peak}}}$	0.13	nm/K
Temperaturkoeffizient von $\lambda_{\text{dom}}$ (typ.) Temperature coefficient of $\lambda_{\text{dom}}$ $I_F = 20\text{ mA}; -10\text{ °C} \leq T \leq 100\text{ °C}$	$TC_{\lambda_{\text{dom}}}$	0.10	nm/K
Temperaturkoeffizient von $V_F$ (typ.) Temperature coefficient of $V_F$ $I_F = 20\text{ mA}; -10\text{ °C} \leq T \leq 100\text{ °C}$	$TC_V$	- 2.5	mV/K
Optischer Wirkungsgrad (typ.) Optical efficiency $I_F = 20\text{ mA}$	$\eta_{\text{opt}}$	11	lm/W

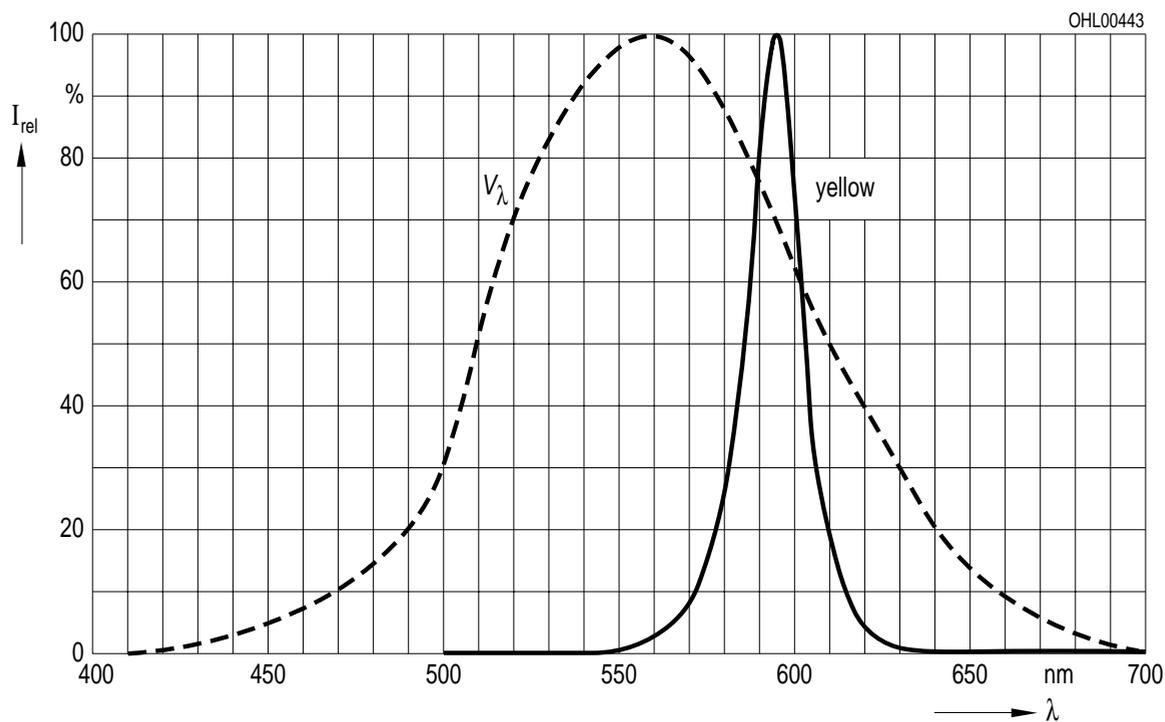
<sup>1)</sup> Spannungswerte werden mit einer Stromeinprägedauer von 1 ms und einer Genauigkeit von  $\pm 0,1\text{ V}$  ermittelt.  
Voltages are tested at a current pulse duration of 1 ms and an accuracy of  $\pm 0.1\text{ V}$ .

Relative spektrale Emission  $I_{rel} = f(\lambda)$ ,  $T_A = 25\text{ °C}$ ,  $I_F = 20\text{ mA}$

**Relative Spectral Emission**

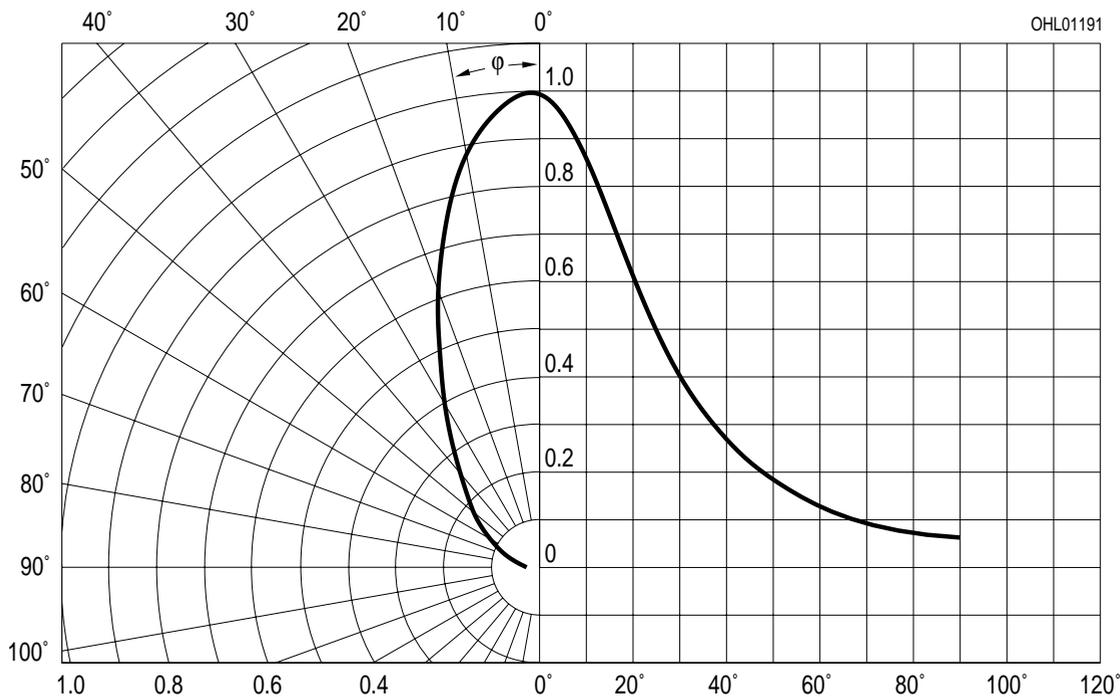
$V(\lambda)$  = spektrale Augenempfindlichkeit

Standard eye response curve



Abstrahlcharakteristik  $I_{rel} = f(\varphi)$

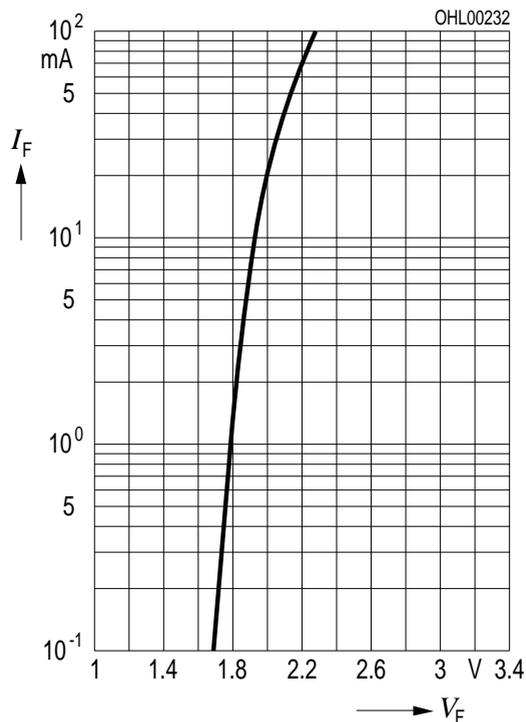
**Radiation Characteristic**



**Durchlassstrom  $I_F = f(V_F)$**

**Forward Current**

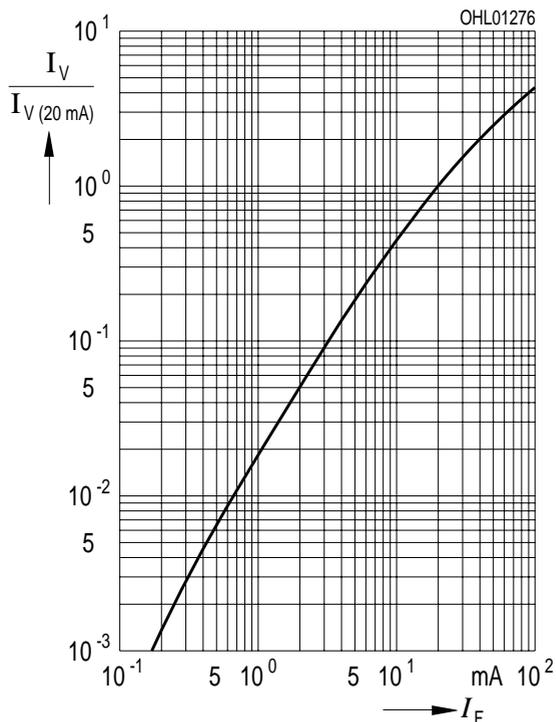
$T_A = 25\text{ °C}$



**Relative Lichtstärke  $I_V/I_{V(20\text{ mA})} = f(I_F)$**

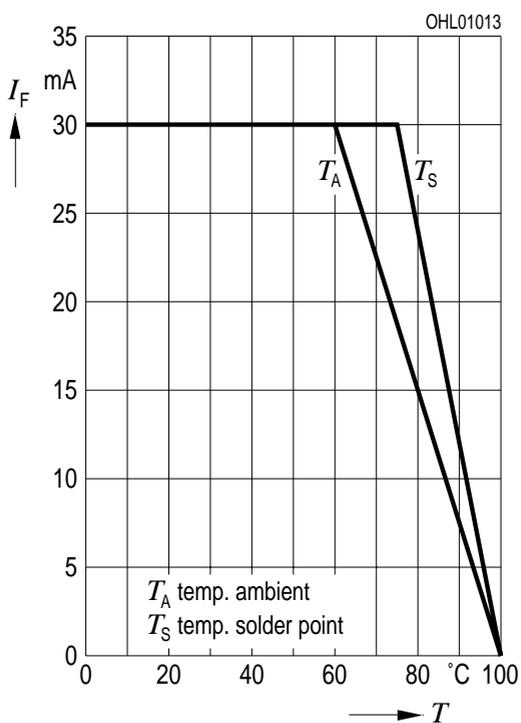
**Relative Luminous Intensity**

$T_A = 25\text{ °C}$



**Maximal zulässiger Durchlassstrom  $I_F = f(T)$**

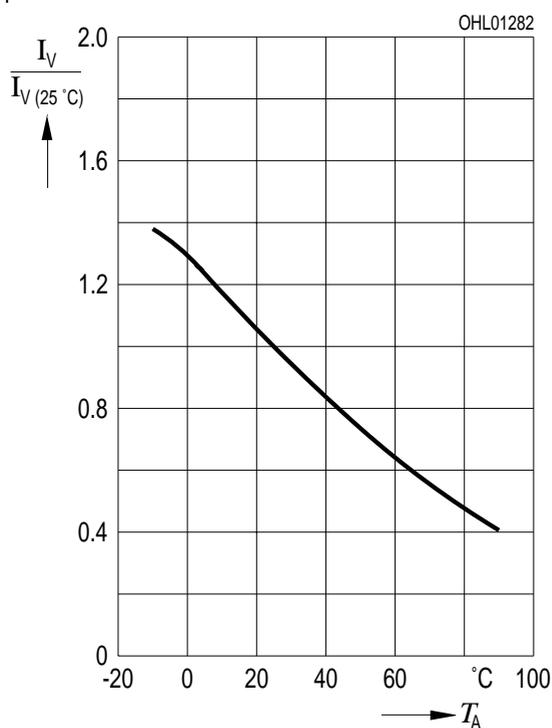
**Max. Permissible Forward Current**



**Relative Lichtstärke  $I_V/I_{V(25\text{ °C})} = f(T_A)$**

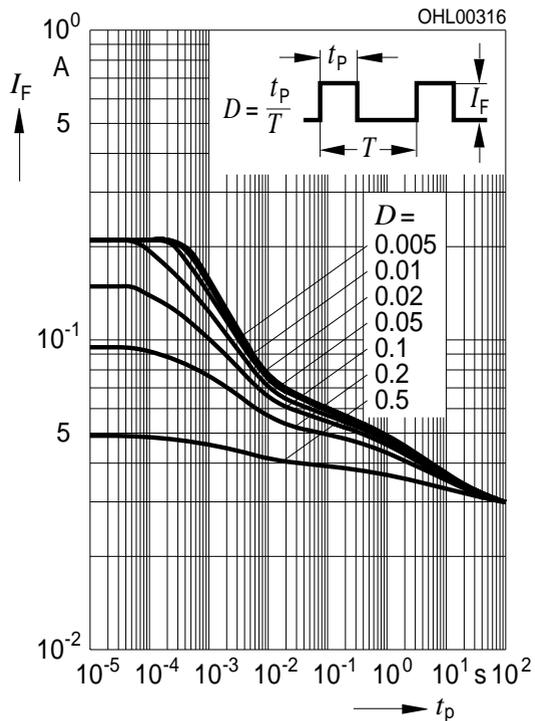
**Relative Luminous Intensity**

$I_F = 20\text{ mA}$



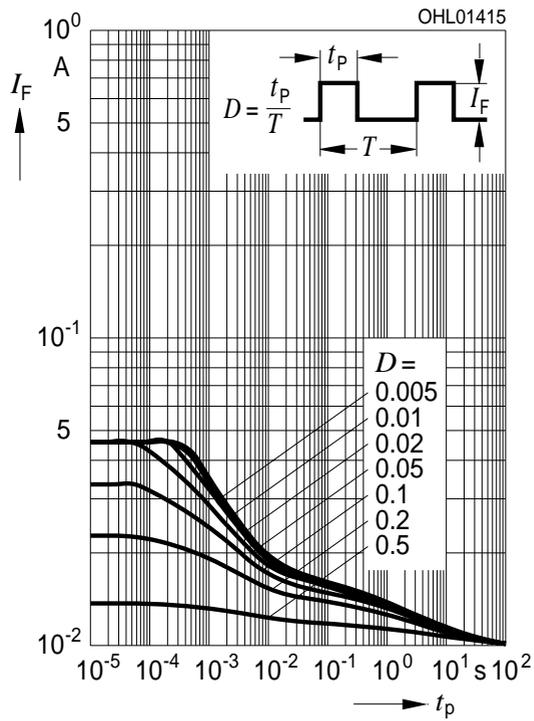
**Zulässige Impulsbelastbarkeit  $I_F = f(t_p)$**   
**Permissible Pulse Handling Capability**

Duty cycle  $D =$  parameter,  $T_A = 25\text{ °C}$

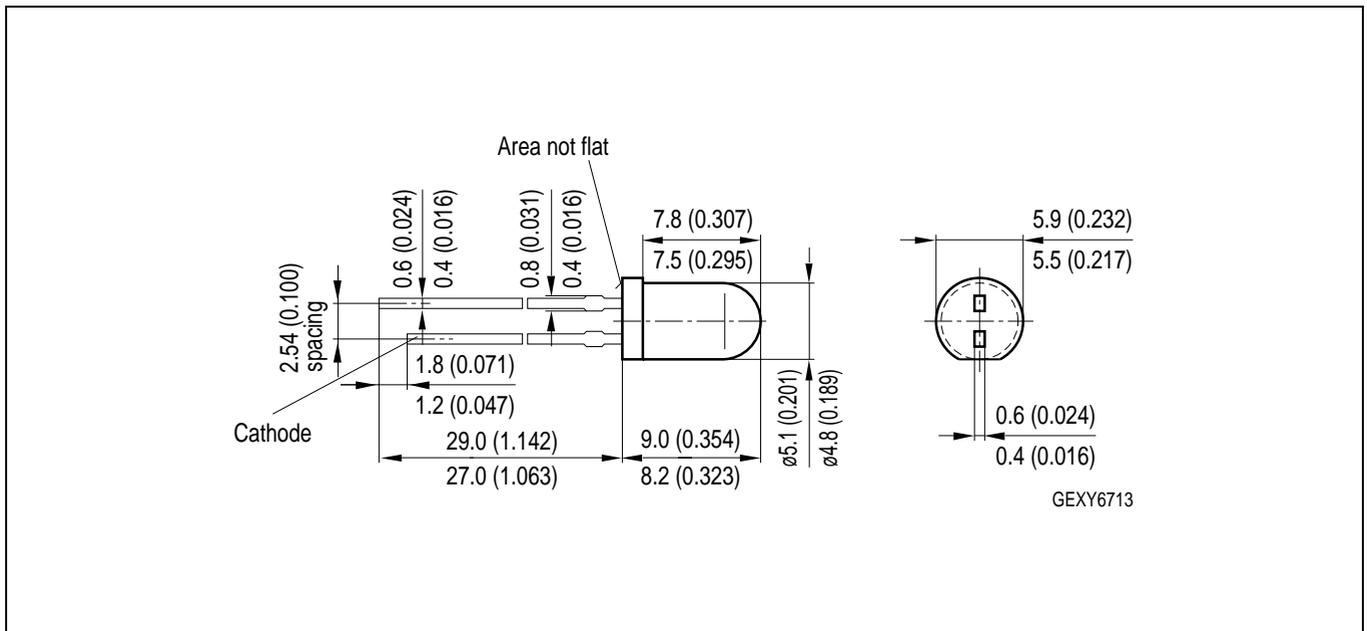


**Zulässige Impulsbelastbarkeit  $I_F = f(t_p)$**   
**Permissible Pulse Handling Capability**

Duty cycle  $D =$  parameter,  $T_A = 85\text{ °C}$



**Maßzeichnung**  
**Package Outlines**

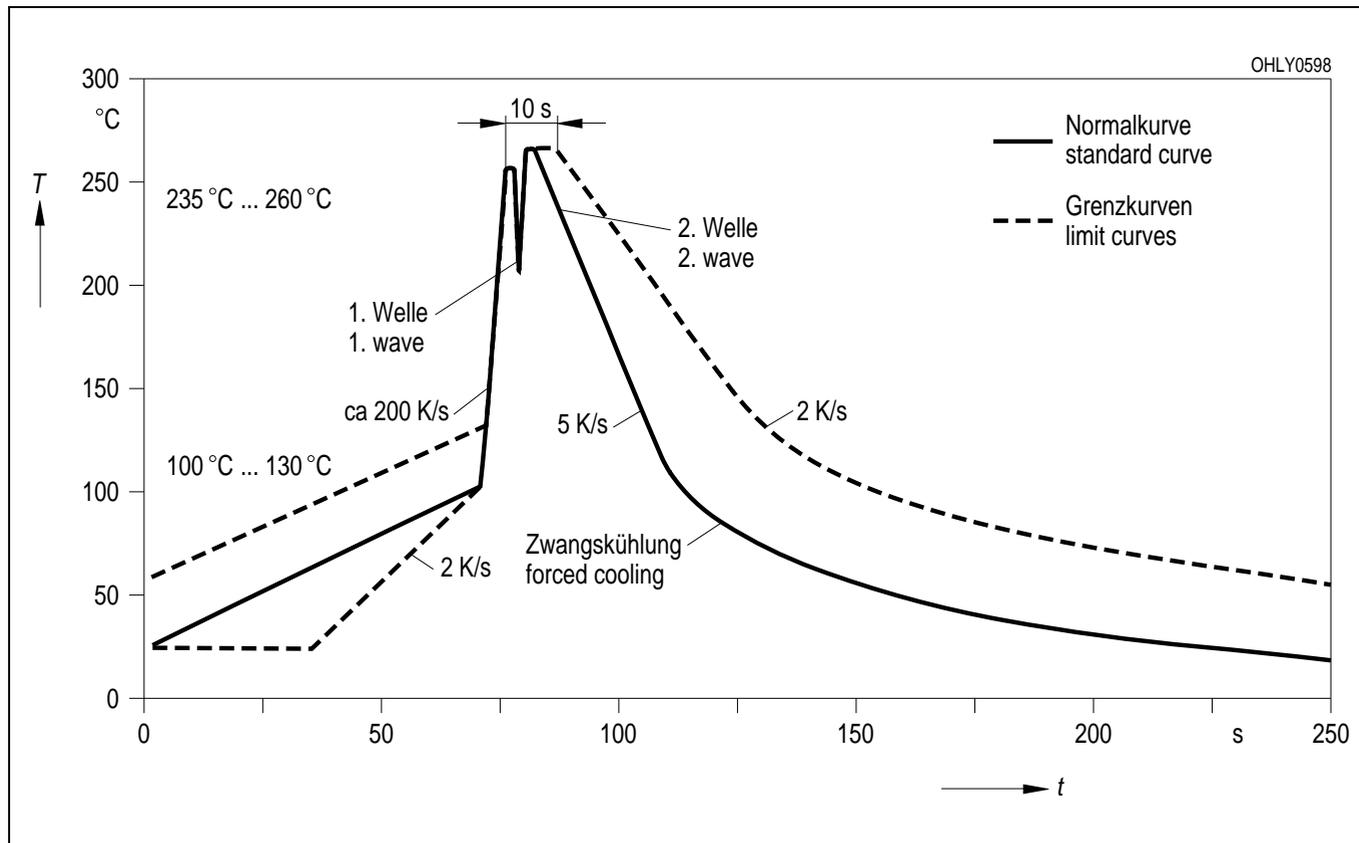


Maße werden wie folgt angegeben: mm (inch) / Dimensions are specified as follows: mm (inch).

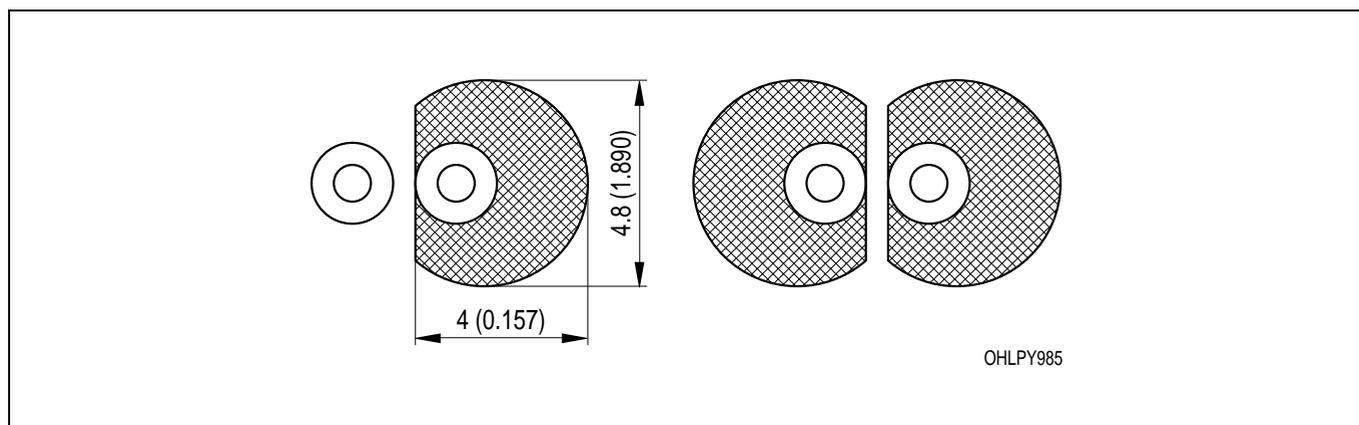
**Kathodenkennung:** kürzerer Lötspieß  
**Cathode mark:** short solder lead  
**Gewicht / Approx. weight:** 0.35 g

**Lötbedingungen**  
**Soldering Conditions**

**Wellenlöten (TTW)** (nach CECC 00802)  
**TTW Soldering** (acc. to CECC 00802)



**Empfohlenes Lötpaddesign** Wellenlöten (TTW)  
**Recommended Solder Pad** TTW Soldering



Maße werden wie folgt angegeben: mm (inch) / Dimensions are specified as follows: mm (inch)

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**Revision History: 2001-02-23**

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Previous Version: 2001-02-23

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Page	Subjects (major changes since last revision)

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